



## 20V N-Channel Trench Power MOSFET

### General Description

The SJM20N036A uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a wide variety of applications.

### Features

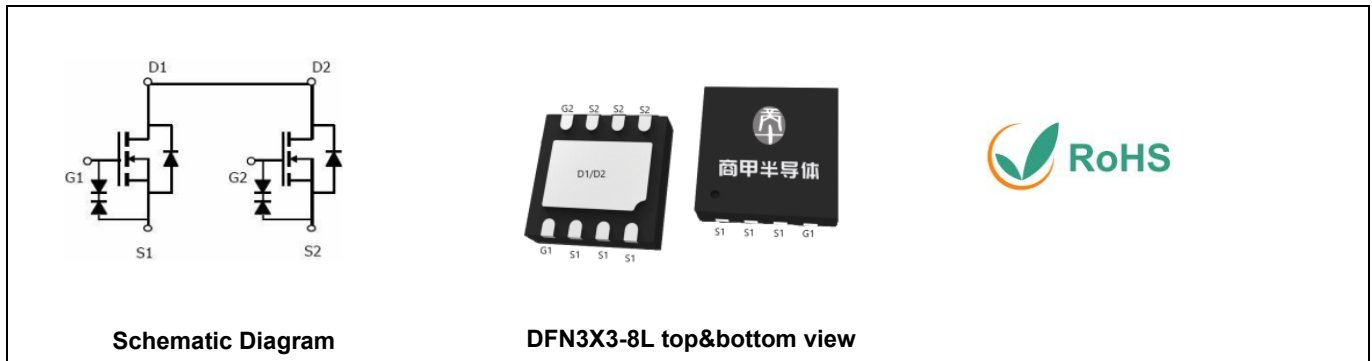
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired
- ESD Rating: HBM 2KV

### Application

- Load Switch

### Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	20	V
$R_{DS(ON\_TYP)}$	3.6	m $\Omega$
$I_D$	60	A
$Q_G$	64	nC



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJM20N036A	SJM20N036	DFN3X3-8L	Tape	\	\	5000 Pcs

**Table 1. Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	20	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 10$	V
$I_D$	Drain Current-Continuous( $T_C=25^\circ\text{C}$ )	60	A
	Drain Current-Continuous( $T_C=100^\circ\text{C}$ )	38	A
$I_{DM}$ (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	240	A
$P_D$	Maximum Power Dissipation( $T_C=25^\circ\text{C}$ )	25	W
	Maximum Power Dissipation( $T_C=100^\circ\text{C}$ )	10	W
$E_{AS}$	Avalanche energy (Note 2)	132	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		5	$^\circ\text{C}/\text{W}$



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**Table 3. Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
B <sub>V</sub> DSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V T <sub>J</sub> =25°C			1	μA
		V <sub>DS</sub> =20V, V <sub>GS</sub> =0V T <sub>J</sub> =125°C			100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±10V, V <sub>DS</sub> =0V			±10	uA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.5		1	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =8A		50		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =8A T <sub>J</sub> =25°C		3.6	4.7	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =2.5V, I <sub>D</sub> =6A T <sub>J</sub> =25°C		4.6	6.1	mΩ
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f=1.0KHz		1790		pF
C <sub>oss</sub>	Output Capacitance			235		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			184		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		2.8		kΩ
<b>Switching Parameters</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, R <sub>L</sub> =1.25Ω, R <sub>GEN</sub> =3Ω		10		nS
t <sub>r</sub>	Turn-on Rise Time			25		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			72		nS
t <sub>f</sub>	Turn-Off Fall Time			80		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, I <sub>D</sub> =8A		64		nC
Q <sub>gs</sub>	Gate-Source Charge			8		nC
Q <sub>gd</sub>	Gate-Drain Charge			12		nC
<b>Source-Drain Diode Characteristics</b>						
I <sub>SD</sub>	Source-Drain Current (Body Diode)				60	A
V <sub>SD</sub>	Forward on Voltage <sup>(Note 3)</sup>	V <sub>GS</sub> =0V, I <sub>S</sub> =8A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =8A, dI/dt=100A/μs		16		ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> =8A, dI/dt=100A/μs		5.5		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

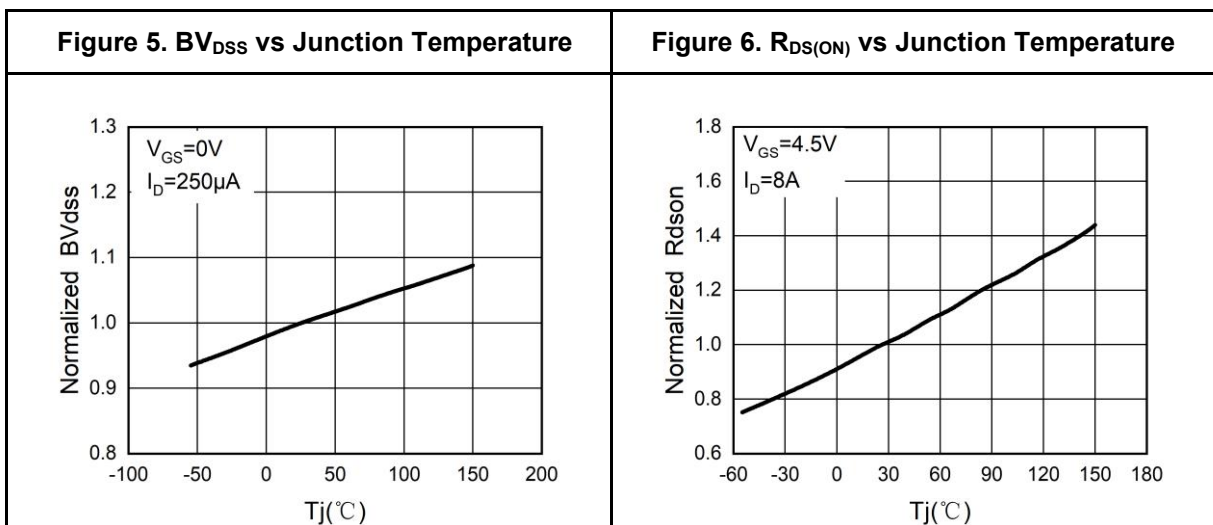
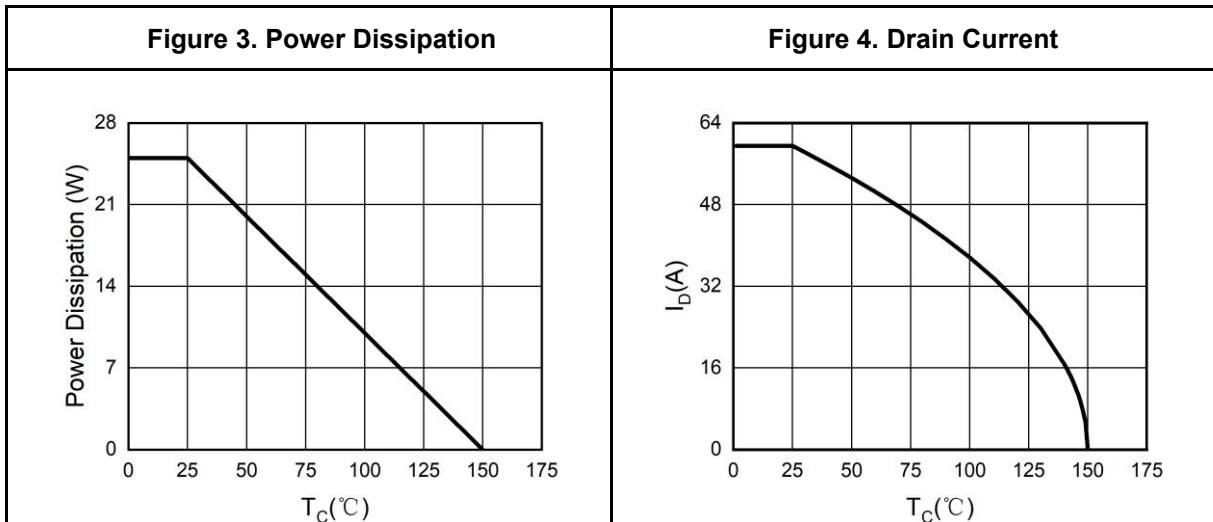
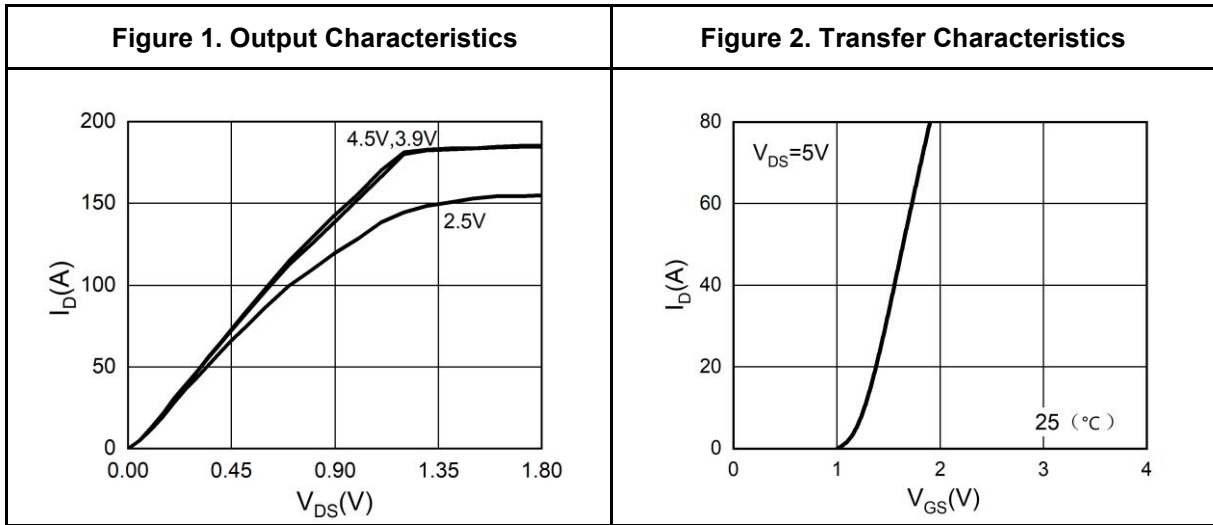
Notes 2.EAS condition: T<sub>J</sub>=25°C, V<sub>DD</sub>=10V, V<sub>G</sub>=10V, R<sub>g</sub>=25Ω, L=0.5mH.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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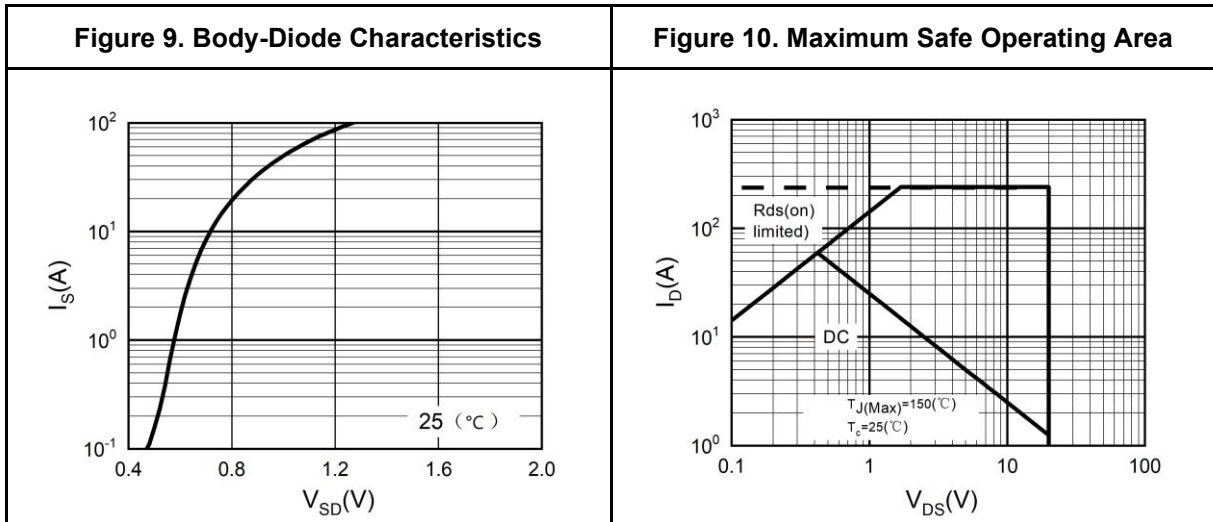
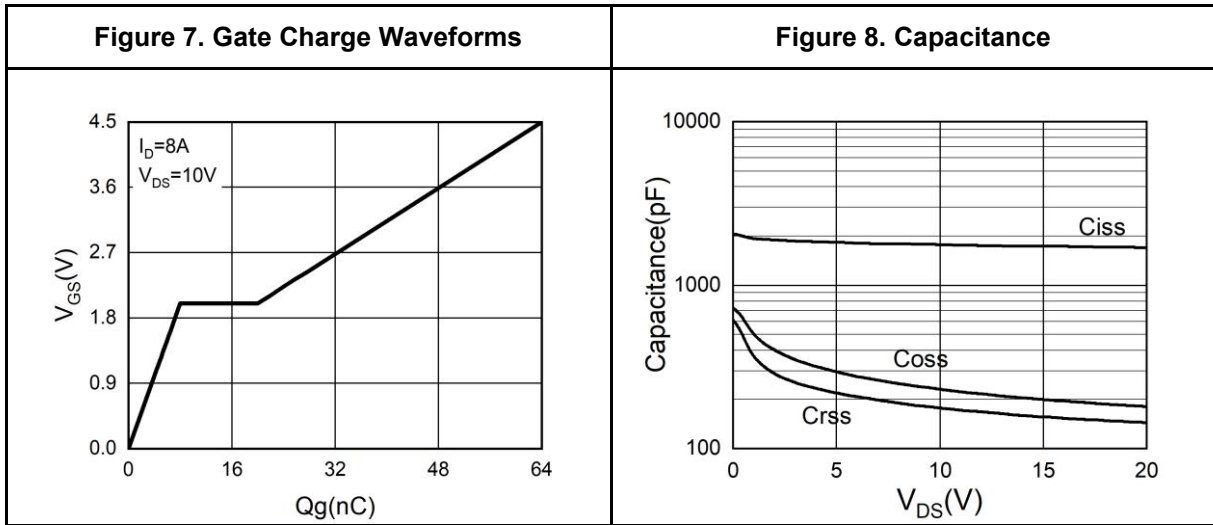
## Typical Electrical And Thermal Characteristics (Curves)





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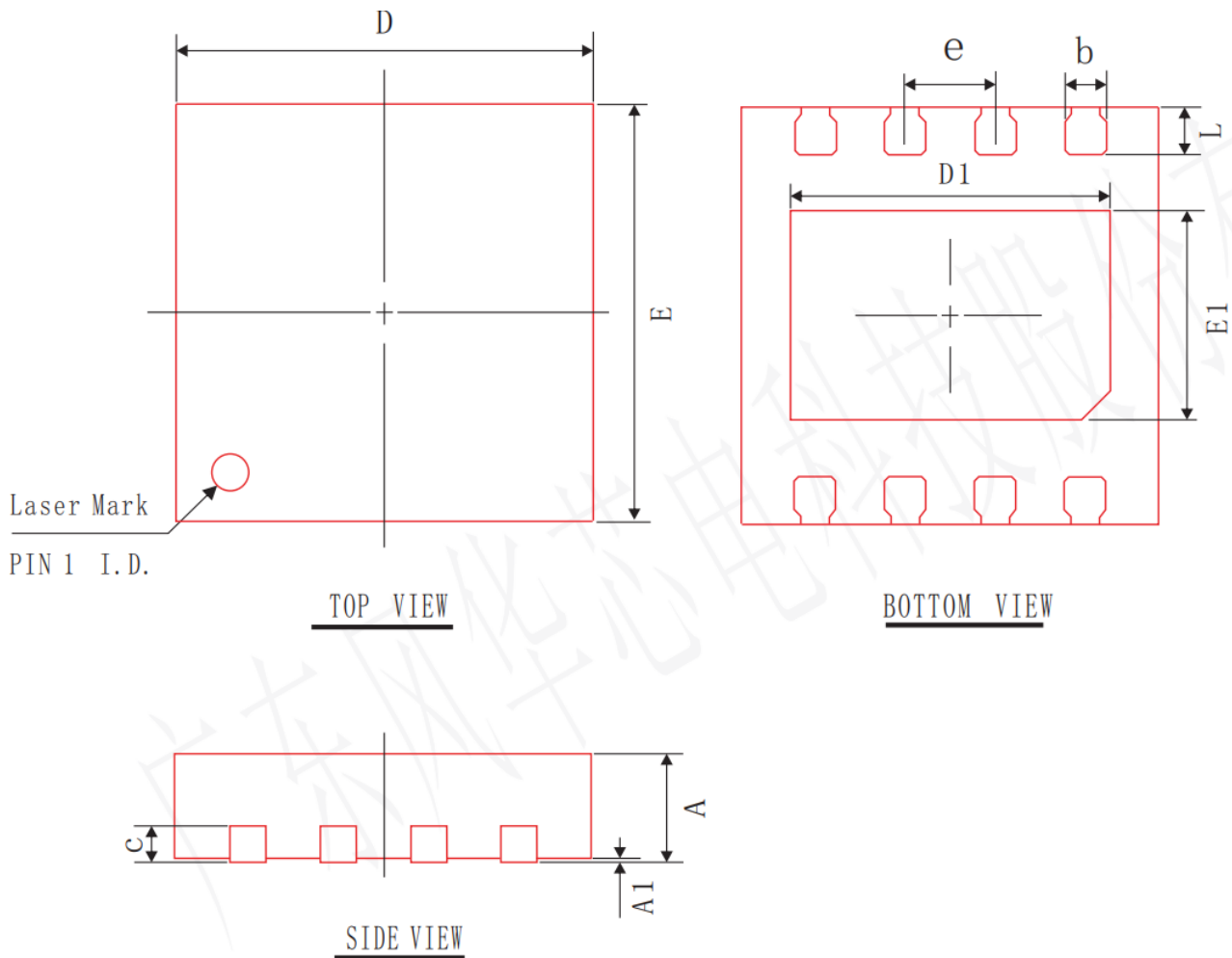
## Typical Electrical And Thermal Characteristics (Curves)





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### DFN3X3-8L Package Information



COMMON DIMENSIONS  
(UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
b	0.25	0.30	0.35
D	2.95	3.00	3.07
E	2.95	3.00	3.07
D1	2.25	2.30	2.35
E1	1.40	1.50	1.60
L	0.25	0.35	0.45
c	0.203 REF		
e	0.65 BSC		

其它厚度尺寸如下

A	0.55	0.60	0.65
A	0.50	0.55	0.60



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### Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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